

Ph. 480-503-4295 | NOPP@FocusLCDs.com

TFT | OLED | CHARACTER | GRAPHIC | UWVD | SEGMENT | CUSTOM

TFT Display Module

Part Number E101GB-RW200-R

Overview:

- 10.1-inch TFT (235x143mm)
- RGB Interface
- 1024x600 pixels
- 6:00 Viewing Angle
- White LED back-light

- Transmissive / Normally White
- Resistive Touch Panel
- 200 NITS
- Controller: HX8282A01 + HX8696A01
- RoHS Compliant



Description

This is a color active matrix TFT (Thin Film Transistor) LCD (Liquid Crystal Display) that uses amorphous silicon TFT as a switching device. This model is composed of a transmissive type TFT LCD Panel, driver circuit, resistive touch panel and an RGB board backlight unit. The resolution of a 10.1" TFT LCD contains 1024(RGB)x600 pixels and can display up to 16M colors.

TFT Features

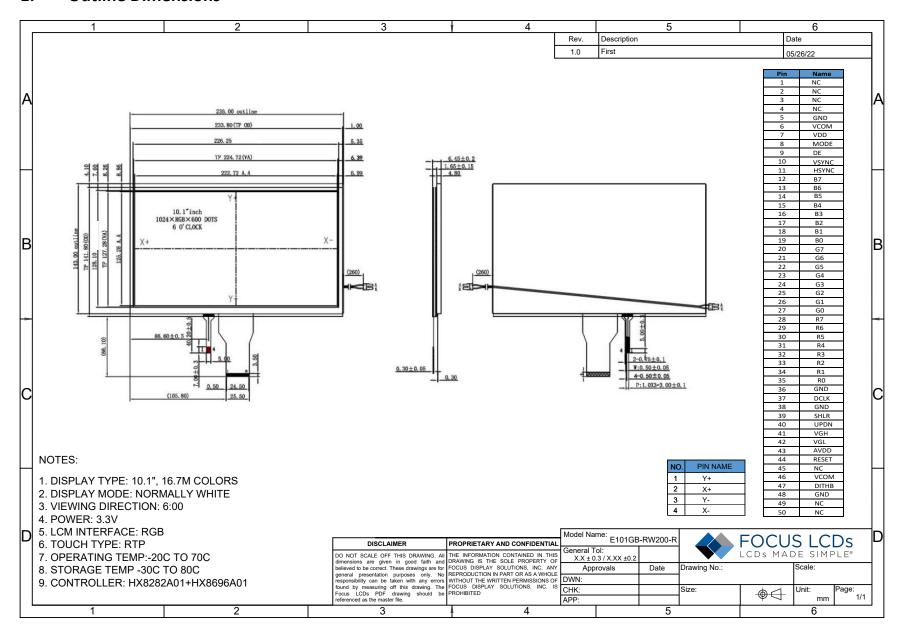
Input Voltage: 3.3V Display Colors: 16M TFT Interface: RGB

| General Information Items | Specification Main Panel | Unit | Note |
|---------------------------|----------------------------------|--------|------|
| TFT Display area (AA) | 222.72(W) ×125.28(H) (10.1 inch) | mm | - |
| Driver Element | a-Si TFT active matrix | - | - |
| Display Colors | 16M | colors | - |
| Number of pixels | 1024(RGB)x600 | dots | - |
| TFT Pixel arrangement | RGB vertical stripe | - | - |
| Pixel Pitch | 0.2175 (H) x 0.2088 (V) mm | mm | - |
| Viewing angle | 6:00 | - | - |
| Display mode | Transmissive, Normally White | - | - |
| TFT Controller | HX8282A01+HX8696A01 | - | - |
| Operating temperature | -20 - +70 | °C | - |
| Storage temperature | -30 - +80 | °C | - |

Mechanical Information

| ltem | | Min | Тур. | Max | Unit | Note |
|--------|----------------|-----|------|-----|------|------|
| | Horizontal (H) | | 235 | | mm | - |
| Module | Vertical (V) | | 143 | | mm | - |
| Size | Depth (D) | | 6.45 | | mm | - |
| | Weight | | tbd | | g | |

1. Outline Dimensions



3



2. Input Terminal Pin Assignment

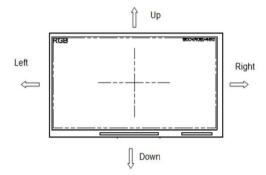
| Pin | Name | I/O | Function | Notes |
|-------|-------|-----|--|-------|
| 1-2 | NC | - | No connection | |
| 3-4 | NC | - | No connection | |
| 5 | GND | P | Ground | |
| 6 | VCOM | p | Common Voltage | |
| 7 | VDD | P | Power for Digital Circuit | |
| 8 | MODE | I | DE/SYNC mode select | |
| 9 | DE | I | Data Input Enable | |
| 10 | VSYNC | I | Vertical Sync Input | |
| 11 | HSYNC | I | Horizontal Sync Input | |
| 12-19 | B7-B0 | I | Blue data,B7 is MSB,B0 is LSB. | |
| 20-27 | G7-G0 | I | Green data,G7 is MSB,G0 is LSB. | |
| 28-35 | R7-R0 | I | Red data,R7 is MSB,R0 is LSB. | |
| 36 | GND | P | Power ground | |
| 37 | DCLK | I | Sample clock | |
| 38 | GND | P | Power ground | |
| 39 | SHLR | I | Left/right selection | |
| 40 | UPDN | I | Up/down selection | |
| 41 | VGH | P | Gate ON Voltage | |
| 42 | VGL | P | Gate OFF Voltage | |
| 43 | AVDD | P | Power for Analog Circuit | |
| 44 | RESET | I | Global reset pin. | |
| 45 | NC | - | No connect | |
| 46 | VCOM | p | Common Voltage | |
| 47 | DITHB | I | Dithering function enable control. Normally pull low In LVDS 6-bit mode, IC don't care DITHER and HFRC setting. DITHER = "1", Enable internal dithering function DITHER = "0", Disable internal dithering function. | |
| 48 | GND | P | Power ground | |
| 49-50 | NC | _ | No connection | |



2.2 Scanning Mode Selection

| Setting of s | scan control input | |
|--------------|--------------------|---------------------------|
| UPDN | SHLR | Scanning direction |
| GND | VDD | Up to down, left to right |
| VDD | GND | Down to up, right to left |
| GND | GND | Up to down, right to left |
| VDD | VDD | Down to up, left to right |

Refer to the figure as below:





3. LCD Optical Characteristics

3.1 Optical Specifications

| ltem | | Symbol | Condition | Min | Тур. | Max | Unit |
|------------------|----------------|------------------|----------------|-------|-------|-------|--------|
| Uniformity | | S(%) | | | 80 | | % |
| Contrast Ra | Contrast Ratio | | | 500 | 600 | | % |
| Dosnonso Timo | Rising | T _{ON} | | - | 10 | 15 | |
| Response Time | Falling | T _{OFF} | | - | 15 | 25 | ms |
| | | W _X | | 0.240 | 0.290 | 0.340 | |
| | White | W _Y | θ=0 | 0.250 | 0.300 | 0.350 | |
| | Dod | Rx | Normal viewing | | | | |
| Color Filter Red | | Ry | angle | | | | |
| Chromaticity | C | Gx | angic | | | | |
| | Green | G _Y | | | | | |
| | Dive | Bx | | | | | |
| | Blue | B _Y | | | | | |
| | | ΘL | | | 65 | | |
| Viewing Angle | Hor. | ΘR | CR≥10 | | 65 | | dograo |
| | | ΘТ | | | 45 | | degree |
| | Ver. | ΘВ | | | 55 | | 1 |
| Option View Dir | ection | | | 6:00 | | | |



4. TFT Electrical Characteristics

4.1 Absolute Maximum Rating (Ta=25 C, VSS=0V)

| Characteristics | Symbol | Min | Max | Unit |
|-----------------------|--------|-----|------|------|
| Power Supply Voltage | VDD | 2.3 | 3.6 | ٧ |
| | AVDD | 6.5 | 13.5 | V |
| Operating Temperature | ТОР | -20 | +70 | °C |
| Storage Temperature | TST | -30 | +80 | °C |

NOTE: If the absolute maximum rating of the above parameters is exceeded, even momentarily, the quality of the product may be degraded. Absolute maximum ratings specify the values which the product may be physically damaged if exceeded. Be sure to use the product within the range of the absolute maximum ratings.

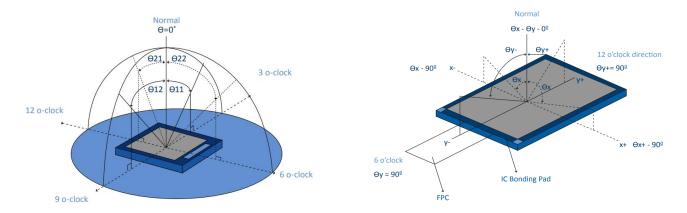
4.2 DC Electrical Characteristics

| Power where | Completel | Spec | | I I with | Condition | |
|-------------------------------------|-----------|---------|--------|----------|-----------|--|
| Parameter | Symbol | Min | Тур | Max | Unit | Condition |
| Power Supply Voltage | VDD | 2.3 | - | 3.6 | V | - |
| Power Supply Voltage | AVDD | 6.5 | - | 13.5 | V | - |
| Power Supply Voltage | AVDDL | 6.5 | - | 13.5 | V | Full Range |
| Power Supply Voltage | AVDDL | 4 | - | 6.75 | V | Half AVDD |
| Dower Supply Voltage | AGNDH | | 0 | | V | Full Range |
| Power Supply Voltage | AGNUH | 4 | - | 6.75 | V | Half AVDD |
| Low Level Input Voltage | VIL | 0 | - | 0.3VDD | V | For Digital Circuit |
| High Level input Voltage | VIH | 0.7VDD | - | VDD | V | For Digital Circuit |
| Output low voltage | VOL | - | - | GND+0.4 | V | IOL=400uA |
| Outputhigh voltage | VOH | VDD04 | - | - | V | IOH=-400uA |
| Pull low/high resistance | RI | 200 | 250 | 300 | Kohm | For digital input pin at VDD=3.3V |
| Input Leakage Current | LI | - | - | +/-1 | uA | For digital Circuit |
| Digital Operation Current | LDD | - | 12 | 20 | mA | FCLK=50MHz,LD=48KHz,VDD=3.3V, No Load |
| Digital Standby current | LST1 | - | 10 | 50 | uA | Clock and all functions are stopped |
| Analog Operating Current | LDDA | - | 8 | 10 | mA | No Load, Fclk=50MHz, LD=48KHz@AVDD=10V, V1=8V,V14=0.4V |
| Analog Standby Current | LST2 | - | 10 | 50 | uA | No Load, clock and all functions are stopped |
| Input level of v1-v7 | VREF1 | 0.4AVDD | - | AVDD-0.1 | V | Gamma correction voltage input |
| input level of v8-v14 | VREF2 | 0.1 | - | 0.6AVDD | V | Gamma correction voltage input |
| Output Voltage Deviation | VOD1 | - | +/-20 | +/-35 | mV | Vo=AGND+0.1V~AGND+0.5V & Vo=AVDD-0.5V~AVD-0.1v |
| Output Voltage Deviation | VOD2 | - | +/-15 | +/-20 | mV | Vo=AGND+0.5V~AVDD-0.5V |
| Output Voltage Offset Between Chips | VOC | - | - | +/-20 | mV | Vo=AGND+0.5V~AVDD-0.5V |
| Dynamic Range of Output | VDR | 0.1 | - | AVDD-0.1 | V | SO1~SO1200 |
| Sinking Current of Outputs | IOLY | 80 | - | - | uA | SO1~so1200; Vo=0.1V vs. 1.0V, AVDD=13.5V |
| Driving Current of Outputs | IOHY | 80 | - | - | uA | SO1~so1200; Vo=0.1V vs. 1.0V, AVDD=13.5V |
| Resistance of Gamma Table | RG | 0.7Rn | 1.0*Rn | 1.3*Rn | Ohm | Rn: Internal Gamma Resistor |



Optical Specification Reference Notes:

(1) Definition of Viewing Angle: The viewing angle is the angle at which the contrast ratio is greater than 10. The viewing angles are determined for the horizontal or 3,9 o'clock direction and the vertical or 6,12 o'clock direction with respect to the optical axis which is normal to the LCD surface.



(2) Definition of Contrast Ratio (Cr): measured at the center point of panel. The contrast ratio (Cr) measured on a module, is the ratio between the luminance (Lw) in a full white area (R=G=B=1) and the luminance (Ld) in a dark area (R=G=B=0).

$$Cr = \frac{Lw}{Ld}$$

(3) Definition of transmittance (T%): The transmittance of the panel including the polarizers is measured with electrical driving. The equation for transmittance Tr is:

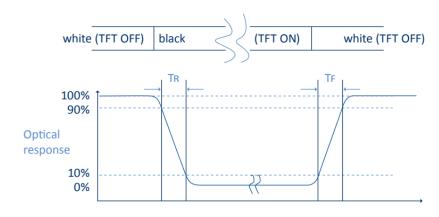
$$Tr = \frac{It}{x} 100\%$$

 $\begin{array}{c|c} & I_o & I_t \\ \hline \\ light source & LCD panel \end{array}$

Io = the brightness of the light source.

It = the brightness after panel transmission

(4) Definition of Response Time (Tr, Tf): The rise time 'Tr' is defined as the time for luminance to change from 90% to 10% as a result of a change of the electrical condition. The fall time 'Tf' is defined as the time for luminance to change from 10% to 90% as a result of a change of the electrical condition.





(5) Definition of Color Gamut:

Measuring machine CFT-01. NTSC's Primaries: R(x,y,Y),G(x,y,Y), B(x,y,Y). FPM520 of Westar Display Technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics. The color chromaticity shall be calculated from the spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the panel.

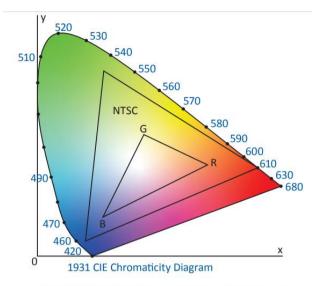
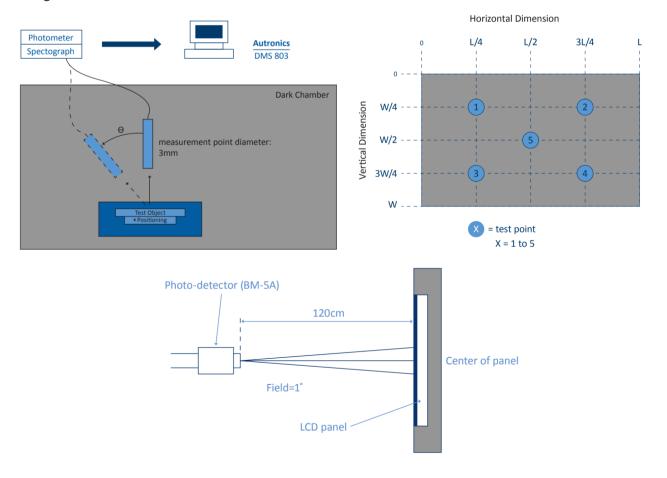


Fig. 1931 CIE chromacity diagram

Color gamut: $S = \frac{\text{Area of RGB triangle}}{\text{Area of NTSC triangle}} \times 100\%$

(6) Definition of Optical Measurement Setup:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 20 minutes.





4.3 LED Backlight Characteristics

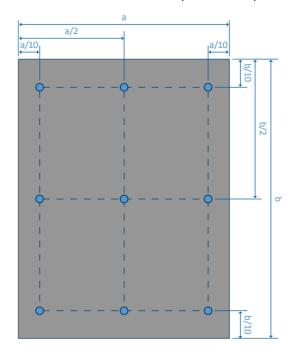
The backlight system is edge lighting type with 30 chips LED

| Item | Symbol | Min | Тур. | Max | Unit | Note |
|-----------------------|--------|--------|------|-----|-------|--------------|
| LED Backlight Current | lL | | 240 | | mA | |
| LED Backlight Voltage | VL | 8.5 | 9 | 9.5 | V | |
| LCM Luminance | LV | | 200 | | cd/m2 | Note 3 |
| LED lifetime | Hr | 20,000 | | | hour | Note1 & 2 |
| Uniformity | Avg | 70 | 80 | | % | Note 3 |

Note 1: LED lifetime (Hr) can be defined as the time in which it continues to operate under the condition: $Ta=25\pm3$ °C, typical IL value indicated in the above table until the brightness becomes less than 50%.

Note 2: The "LED lifetime" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and IL = 240mA. The LED lifetime could be decreased if operating IL is larger than 240 mA. The constant current driving method is suggested.

Note 3: Luminance Uniformity of these 9 points is defined as below:



Uniformity = minimum luminance in 9 points(1-9) maximum luminance in 9 points(1-9)



5.) Timing Characteristics

For more information on timing characteristics of this module, please see https://focuslcds.com/content/HX8282.pdf

6.) Quality Inspection Information

For more information on quality inspection of this module, please visit: https://focuslcds.com/content/LCD%20Quality%20Inspection%20Standards.pdf



7. Cautions and Handling Precautions

7.1 Handling and Operating the Module

- 1. When the module is assembled, it should be attached to the system firmly. Do not warp or twist the module during assemblywork.
- 2. Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.
- 3. Note that polarizer is very fragile and could be easily damaged. Do not press or scratch thesurface.
- 4. Do not allow drops of water or chemicals to remain on the display surface. If you have the droplets for a long time, staining and discoloration may occur.
- 5. If the surface of the polarizer is dirty, clean it using some absorbent cotton or softcloth.
- 6. The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane. Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.
- 7. If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.
- 8. Protect the module from static; it may cause damage to the CMOSICs.
- 9. Use fingerstalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.
- 10. Do not disassemble the module.
- 11. Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.
- 12. Pins of I/F connector shall not be touched directly with bare hands.
- 13. Do not connect, disconnect the module in the "Power ON" condition.
- 14. Power supply should always be turned on/off by the item Power On Sequence & Power Off Sequence.

7.2 Storage and Transportation.

- 1. Do not leave the panel in high temperature, and high humidity for a long time. It is highly recommended to store the module with temperature from 0 to 35 °C and relative humidity of less than 70%
- 2. Do not store the TFT-LCD module in direct sunlight.
- 3. The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.
- 4. It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module. In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.
- 5. This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.